

PLATEA Procesadores P- 8



Model	835	840	845	860
Plate	CTP Plate			
Width of plate	880mm	1100mm	1250mm	1500mm
Thickness of plate	0.12mm-0.40mm			
Handling speed of plate	14-65s			
Set Temperature of developer	15°C-35°C			
Developer liquid heating speed	0.3°C/min			
Cooling speed of developer liquid	0.2°C/min			
Developer Liquid Replenishment System	Auto-supplement, boot supplement			
Developer slot volume	45L	55L	65L	75L
Glue volume	Recycle			
Drying temperature setting	30°C - 65°C			
Developer roller speed	50 - 120rpm			
Washing roller speed	50-120rpm			
Temperature Control Accuracy of Developer Liquid	±0.3°C			
Power	Single Phase 220VAC/50-60HZ/4Kw			
Equipment size	1300x3000	1450x3100	1620x3250	1870x3600
Weight	500KG	600KG	700KG	800KG